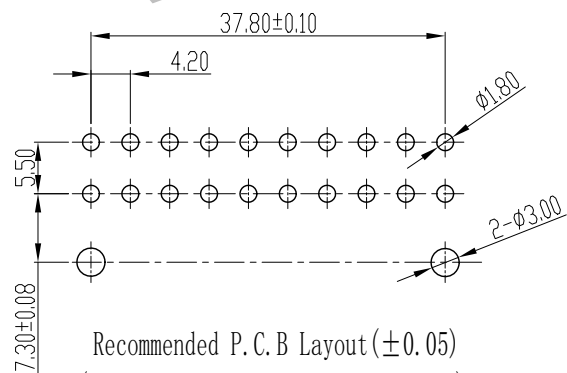
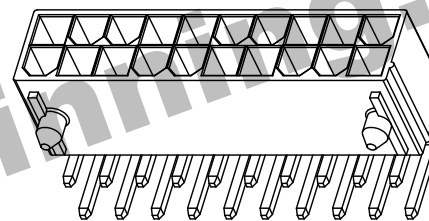
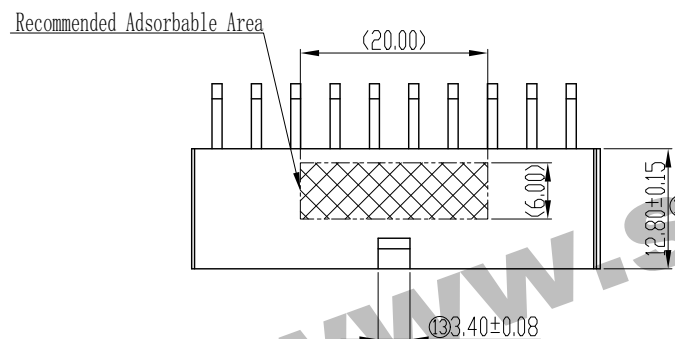


Section M-M



Recommended P.C.B Layout ( $\pm 0.05$ )  
(Recommended P.C.B Thick 2.0 Max.)

Unless otherwise specified tolerance:

X.	$\pm 0.50$	X. °	$\pm 3^\circ$
.X	$\pm 0.38$	.X °	$\pm 2^\circ$
.XX	$\pm 0.25$		

#### Performance characteristics:

##### 1. Main body part material

Housing: LCP Nature UL94V-0

Contact terminal: brass, 1.27~2  $\mu$ m Ni under plated,  
outer plating Matte Sn 3.81  $\mu$ m Min.

##### 2. Electrical requirements:

Current rating: 9A

Voltage rating: 600 V

Contact resistance:  $\leq 10$  m $\Omega$

Insulation resistance:  $\geq 1000$  M $\Omega$

Withstanding voltage: 1500 Vr.m.s, 1mA, 60s

##### 3. Mechanical requirements

Retention force:  $\geq 10$  N/pin

##### 4. Environment specification

Working temperature: -40°C~105°C

Humidity:  $\leq 93\%$  at 40°C

Resistance to soldering heat: 260°C, 30s

##### 5. Packing & storing



Method of packing: tape&reel, outer box

Storing condition: temperature of -10°C~+40°C  
below 80% relative humidity

##### 6. Style of installation: solder pcb installation(PIP)

##### 7. To prevent the pollution of the environment product info

RoHS agreement: In line with the european union RoHS.

					4.20mm Pitch Wafer Dual Row R/A 2x10Pin (Customer:HUAWEI)	SLO. 1348. 015			
②	2	379921	Change Yu	2019.04.16					
Mark	NO.	File NO.	Signature	Date					
DRAW		Change Yu 2018. 08. 13							
CHK					1348-204-GB-N		A1		
MAN									
STD						All Dimensions in mm		Sheet 1 of 1	
APP						 SHINNING SHENZHEN SHINNING ELECTRONIC CO.,LTD.			